

# HSF RoHS

## SPECIFICATIONS

Rated Current:2.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:500V AC/DC

Insulation Resistance:500MΩ Min

Operation Temperature:-40°C to +105°C

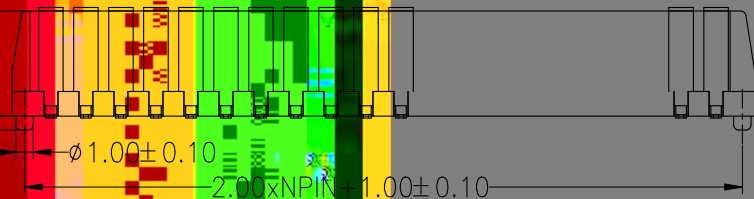
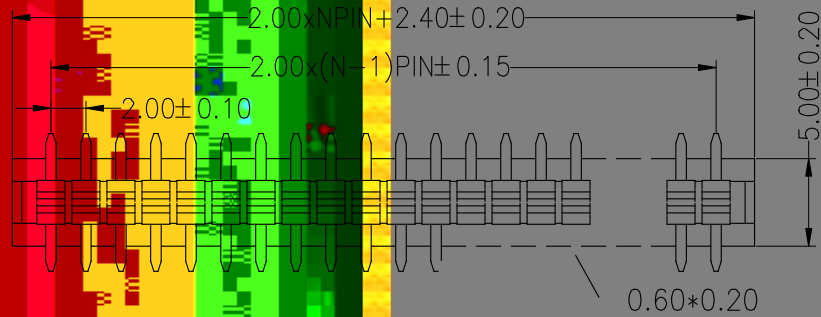
Contact Material:Copper Alloy

Contact Plating:Au or Sn Over Ni

Insulator Material:Polyester(UL94V-0)

Resistance To Soldering Heat:

260°C±5°C, 10s(PA9T insulator)



## Ordering Information

4400- 2 XX M XX M E B W 0 X

No.of Pins

- 2x13P
- 2x15P
- 2x20P
- 2x23P
- 2x25P
- 2x27P

Contact Plating

- G0:Gold Flash
- G1:1U" Gold
- G2:2U" Gold
- G3:3U" Gold
- G4:5U" Gold
- G5:10U" Gold

Recommended P.C.B Layout(Top Side)

			OPERATION		DRAW	OuYanghui	18.05.16	SCALE	FIT		
			X.X	±0.30				UNIT	mm		
			CHECK		APPROVE			SIZE	A4	PART NO.	4400-2XXMXXMEBW0X
			X.XXX	±0.10				SHEET	1/1	TITLE:	2.0金手指连接器 2xNP 公座 H6.0 SMT
A0	2018.05.16	NEW DRAWING	CHANGE	Angle	±3°	PROJ.					
REV	DATE	MODIFICATION DESCRIPTION		DIM	TOL						